

RF Power MOSFET Transistor 40 W, 2 - 175 MHz, 28 V

Rev. V1

Features

- N-Channel enhancement mode device
- DMOS structure
- Lower capacitances for broadband operation
- · High saturated output power
- Lower noise figure than bipolar devices
- RoHS Compliant

ABSOLUTE MAXIMUM RATINGS AT 25° C

| Parameter | Symbol | Rating | Units |
|----------------------|------------------|-------------|-------|
| Drain-Source Voltage | V _{DS} | 65 | V |
| Gate-Source Voltage | V _{GS} | 20 | V |
| Drain-Source Current | I _{DS} | 8 | Α |
| Power Dissipation | P _D | 125 | W |
| Junction Temperature | TJ | 200 | °C |
| Storage Temperature | T _{STG} | -55 to +150 | °C |
| Thermal Resistance | θ _{JC} | 1.4 | °C/W |

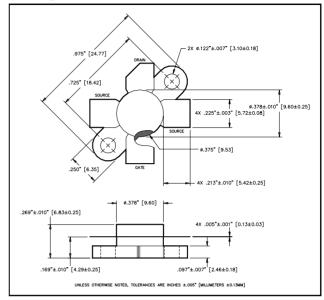
TYPICAL DEVICE IMPEDANCE

| F (MHz) | Z _{IN} (Ω) | Z _{LOAD} (Ω) | | |
|----------------------------------------------------|-----------------------|-----------------------|--|--|
| 30 | 12.0 - j6.8 | 6.5 - j1.5 | | |
| 50 | 10.0 - j6.5 | 6.0 - j1.8 | | |
| 100 | 6.0 - j5.5 | 5.5 - j1.8 | | |
| 200 | 1.1 - j3.0 3.5 - j1.8 | | | |
| V_{DD} = 28V, I_{DQ} = 200mA, P_{OUT} = 40 W | | | | |

 Z_{IN} is the series equivalent input impedance of the device from gate to source.

 $Z_{\text{\tiny LOAD}}$ is the optimum series equivalent load impedance as measured from drain to ground.

Package Outline



| LETTER | MILLIMETERS | | INCHES | |
|--------|-------------|-------|--------|------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 24.64 | 24.89 | .970 | .980 |
| В | 18.29 | 18.54 | .720 | .730 |
| С | 20.07 | 20.83 | .790 | .820 |
| D | 9.47 | 9.73 | .373 | .383 |
| Е | 6.22 | 6.48 | .245 | .255 |
| F | 5.64 | 5.79 | .222 | .228 |
| G | 2.92 | 3.30 | .115 | .130 |
| Н | 2.29 | 2.67 | .090 | .105 |
| J | 4.04 | 4.55 | .159 | .179 |
| К | 6.58 | 7.39 | .259 | .291 |
| L | .10 | .15 | .004 | .006 |

ELECTRICAL CHARACTERISTICS AT 25°C

| Parameter | Symbol | Min | Max | Units | Test Conditions |
|--------------------------------|-------------------|-----|------|-------|---------------------------------------------------------------------------------------|
| Drain-Source Breakdown Voltage | BV _{DSS} | 65 | - | V | V _{GS} = 0.0 V , I _{DS} = 10.0 mA |
| Drain-Source Leakage Current | I _{DSS} | - | 2.0 | mA | V _{GS} = 28.0 V , V _{GS} = 0.0 V |
| Gate-Source Leakage Current | I _{GSS} | - | 2.0 | μA | V _{GS} = 20.0 V , V _{DS} = 0.0 V |
| Gate Threshold Voltage | $V_{GS(TH)}$ | 2.0 | 6.0 | V | V _{DS} = 10.0 V , I _{DS} = 200.0 mA |
| Forward Transconductance | G _M | 1 | - | S | V_{DS} = 10.0 V , I_{DS} = 2000.0 mA , Δ V_{GS} = 1.0V, 80 μs Pulse |
| Input Capacitance | C _{ISS} | - | 90 | pF | V _{DS} = 28.0 V , F = 1.0 MHz |
| Output Capacitance | Coss | - | 80 | pF | V _{DS} = 28.0 V , F = 1.0 MHz |
| Reverse Capacitance | C _{RSS} | - | 16 | pF | V _{DS} = 28.0 V , F = 1.0 MHz |
| Power Gain | G _P | 13 | - | dB | V_{DD} = 28.0 V, I_{DQ} = 200 mA, P_{OUT} = 40 W F =175 MHz |
| Drain Efficiency | ŋ _D | 60 | - | % | V_{DD} = 28.0 V, I_{DQ} = 200 mA, P_{OUT} = 40 W F =175 MHz |
| Load Mismatch Tolerance | VSWR-T | - | 30:1 | - | V_{DD} = 28.0 V, I_{DQ} = 200 mA, P_{OUT} = 40 W F =175 MHz |

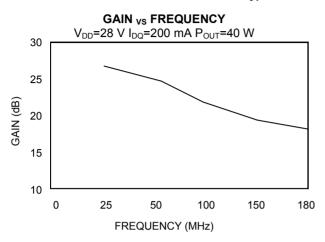
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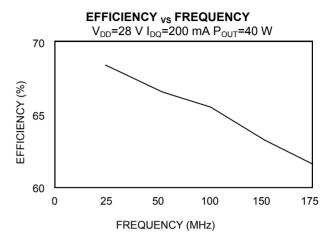


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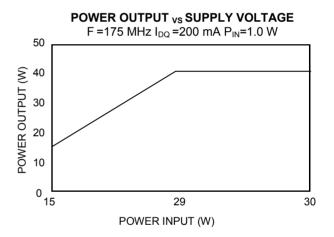
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Typical Broadband Performance Curves





POWER OUTPUT _{VS} POWER INPUT $V_{DD} = 28 \text{ V } I_{DQ} = 100 \text{ mA}$ 60 50 100MHz POWER OUTPUT (W) 175MHz 40 30 20 10 0 0.5 0.1 0.5 1 1.5 0.3 POWER INPUT (W)

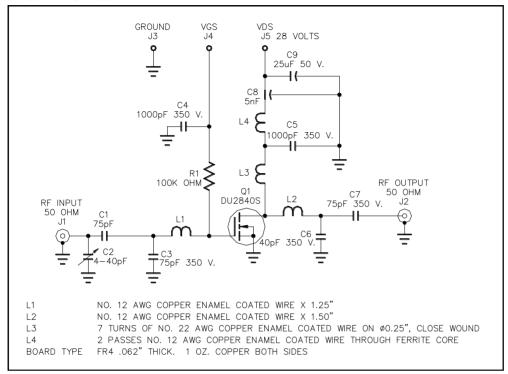




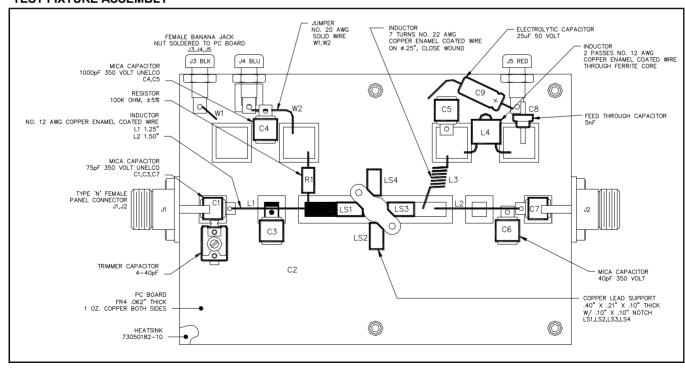
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TEST FIXTURE SCHEMATIC



TEST FIXTURE ASSEMBLY



DU2840S



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